

广州市东裕光电科技有限公司

产品规格书 SPECIFICATION

| 客户名称 CUSTOMER | |
|-----------------|--------------------------|
| 产品名称 PRODUCTION | 贴片光敏二极管 Photot Diode SMD |
| 产品型号 MODEL | DYWH-PD70-01B/1T |
| 版本号 VERSION NO | A1.0 |

地址(Add): 深圳市光明区凤凰街道光明大道 481 号乐府广场 1B 栋 1609-1611 室

厂址(Add): 广东省广州市番禺区石基镇海涌路3号10号厂房2楼

电话(Tel): 18038161512

传真(Fax): 020-39966833

网址(Net): www.tonyuled.cn www.tonyuled.com



| 客户确认 | 审 核 | 编 制 | | |
|-----------------------|------------|-------------|--|--|
| CUSTOMER CONFIRMATION | CHECKED BY | PREPARED BY | | |
| | 周毅兴 | 陈少龙 | | |



DYWH-PD70-01B/1T



产品描述 Descriptions

• DYWH-PD70-01B/1T 由一个顶部接收式 PIN 硅光电二极管组成的 SMD 封装器件. (DYWH-PD70-01B/1T consists Of a PIN silicon photo diode SMD package which is flat top view.)

产品特性 Features

- SMD 光电二极管 (SMD Photodiode)
- 响应时间快 (Fast response time)
- 高灵敏度 (High photo sensitivity)

(Pb free)

- 无铅
- 符合 RoHS 要求 (This product itself will remain within RoHS compliant version)

产品应用 Applications

- 水平仪 (Gradienter)
- 光电开关 (Optoelectronic switch)
- 电焊帽 (Welding helmet)
- 红外键盘 (nfrared keyboard)
- 烟感 (Smoke detector)
- 红外应用系统 (Infrared applied system)

包装方式 Packing Quantity Specification

● 编带 1000 个/卷 (1000 PCS/reel)





、外形图 Outline dimensions:



注: 所有尺寸均为毫米,除非另有说明,公差为±0.1。 Notes: All dimensions are in mm, tolerance is ±0.1 unless otherwise noted.

| 单位 | 公差 | 芯片材料 | 发光颜色 | 胶体颜色 |
|------|-----------|--------------|----------------|------------|
| Unit | Tolerance | Die material | Emission color | Lens color |
| mm | ±0.1mm | Silicon | _ | Black |

※备注:承认书之编号和型号可用于查询,客户如有需要,请提供相应的编号和型号。
 Remark: P/N & Model in samples approval sheet can be used to inquire, please provide corresponding P/N & model if customer need.





二、光电参数 Electro-Optical Characteristics:

(环境温度 Ambient temperature: 25℃,环境湿度 Humidity: RH60%)

| Parameter | Symbol | Condition | Min | Тур | Max | Unit |
|--------------------------------|-----------------|--|-----|-----|------|---------|
| Rang Of Spectral Bandwidth | λ 0.5 | | 730 | | 1100 | nm |
| Wavelength Of Peak Sensitivity | λ Ρ | | | 940 | | nm |
| Short- Circuit Current | I _{SC} | $Ee=1mW/cm^{2}$ $\lambda p=940nm$ | | 35 | | μ A |
| Reverse Light Current | IL | $Ee=1mW/cm^{2}$ $\lambda p=940nm$ $V_{R}=5V$ | 17 | 25 | | μA |
| Reverse Dark Current | I _D | Ee=0mW/cm ² V _R =10V | | 5 | 30 | nA |
| Reverse Breakdown Voltage | V _{BR} | $\begin{array}{c} \text{Ee=0mW/cm}^2\\ \text{I}_{\text{R}}=100 \ \mu \ \text{A} \end{array}$ | 32 | 170 | | v |





三、典型光电特性曲线图 Typical photoelectricity characteristic curve chart:



Fig.2 Reverse Light Current vs. Ee





产品规格书 SPECIFICATION 贴片光敏二极管 DYWH-PD70-01B/1T



四、极限参数 Absolute Maximum Rating:

(环境温度 Ambient temperature: 25℃,环境湿度 Humidity: RH60%)

| 项目 | 符号 | 数值 | 单位 | 备注 | | |
|---------------------------------|----------------|----------------|------|------------------------------|--|--|
| Item | Symbol | Value | Unit | Remark | | |
| 反向电压 | V- | 32 | V | | | |
| Reverse Voltage | V _R | 32 | v | | | |
| 工作环境温度 | Tamb | -25 ~ +85 | °C | | | |
| Operation temperature | Tunio | -25 / 105 | C | | | |
| 贮藏温度 | Tstg | $-40 \sim +85$ | °C | | | |
| Storage temperature | Isig | -40 ~ +85 | C | | | |
| 焊接温度 | Tsol | 260°C for 5s | °C | Reflow soldering 260 5s max. | | |
| Soldering temperature | 1501 | 200°C 10r 3s | C | Kenow soldering 200 3s max. | | |
| 耗散功率 | Dd | 100 | wW/ | | | |
| Power Dissipation | Pd | 100 | mW | | | |
| Notes*1: IFP Conditions-Pulse V | Vidth≤100µs | and Duty≤1% | | | | |

五、可靠性实验项目 Reliability Test Project:

| 描述 | 项目 | 测试标准 | 测试条件 | 测试时间 | 数量 | 失效数量 |
|---|---|---|--|-----------|------|-----------|
| Description | Item | Test criterion | Test condition | Test time | Qty. | Fail Qty. |
| 寿命测试 Life test | 常温寿命测试 Life test (room temperature) | JIS7021:B4 | Ta=25°C±5°C, IF=20mA | 1000Hrs | 22 | 0 |
| | 高温存储 High temperature store | JIS7021:B10 MIL-STD-202:210A MIL-STD-750:2031 | Ta=85°C±5°C | 1000Hrs | 22 | 0 |
| | 低温存储 Low temperature store | JIS7021:B12 | Ta= -35°C±5°C | 1000Hrs | 22 | 0 |
| 环境测试 High temperat Ambience 冷热 test 冷热 Cold / He 冷热 | 高温高湿测试 High temperature/ humidity test | JIS7021:B11 MIL-STD-202:103D | Ta=85°C±5°C RH=85% | 1000Hrs | 22 | 0 |
| | 冷热冲击测试 Cold / Heat strike test | JIS7021:B4 MIL-STD-202:107D MIL-STD-750:1026 | 30min -10°C±5°C←→100°C±5°C 5min 5min | 50Cycles | 22 | 0 |
| | 冷热循环测试 Cold and heat cycle test | JIS7021:A3 MIL-STD-202:107D MIL-STD-705:105E | 5min 5min 5min -35°C~25°C~85°C~-35°C 30min 5min 30min 5min | 50Cycles | 22 | 0 |





六、包装方式 Package Bag Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm ,Unit = mm

Carrier Tape Dimensions:(Quantity: 1000pcs/reel)



Note: The tolerances unless mentioned is ± 0.1 mm ,Unit = mm





七、注意事项 Note

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
 - 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the PHOTODIODEs should be kept at 30° C or less and 90%RH or less.
- 2.3 The PHOTODIODEs should be used within a year.
- 2.4 After opening the package, the PHOTODIODEs should be kept at 30° C or less and 60% RH or less.
- 2.5 The PHOTODIODEs should be used within 168 hours (7 days) after opening the package.
- 2.6 If the moisture absorbent material (silica gel) has faded away or the PHOTODIODEs have exceeded the storage time, baking treatment should be performed using the following conditions.
 Baking treatment : 60±5°C for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the PHOTODIODEs during heating.
- 3.4 After soldering, do not warp the circuit board.
- 4.Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350° C or 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.





5.Repairing

Repair should not be done after the PHOTODIODEs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the PHOTODIODEs will or will not be damaged by repairing.



DISCLAIMER

- 1. TONYU reserves the right(s) on the adjustment of product material mix for the specification.
- 2. The product meets TONYU published specification for a period of twelve (12) months from date of shipment.
- 3. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
- 4. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. TONYU assumes no responsibility for any damage resulting from the use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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